

Chokes for Power Lines

Product Class: Date IMDS ID if available Version:		Ring Core Double Choke B82720A/K2***N*** 26.07.2021 04						
					i 250 V~ 07401- i			
						1		
Product Part (IMDS: semi component)		ial Class :: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part Coromic		4P	Manganaga Zina Farrita	100	10645 40 7	12.1		

Active Part	Ceramic	4B Manganese Zinc Ferrite		100	12645-49-7	42.4	
	Heavy Metal	1C	Cu	100	7440-50-8	13.5	
	Elastomer	2B	Polyurethane (PUR)	100	9009-54-5	0.7	
Encapsulation			Polycarbonate (PC)	89.8	25971-63-5		
and Mounting	Thermoplastic	2A	Glass fiber	10	65997-17-3	26.1	
mounting			PFBS	0.2	29420-49-3		
	Elastomer	2B	Polyurethane (PUR)	100	9009-54-5	12	
	Heavy Metal	1C	Sn	100	7440-31-5	1.6	
Termination			Cu	62	7440-50-8		
	Heavy Metal	1C	Ni	18	7440-02-0	3.5	
			Zn	20	7440-66-6		
	Heavy Metal	1C	Ni	100	7439-89-6		х
	Heavy Metal	1C	Sn	100	7440-31-5	0.2	
Sum in total:					100.0		

Size W x L x H	
[max. in mm]	

Weight Part Numbers [approx. in g]

14,2 x 14,2 x 9,6	2.5	B82720A2***N***
9,5 x 13,3 x 14,3	2.5	B82720K2***N***

Not part of a Product Class

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Contact	Dr. Johann Reindl, MAG	EPQM	Important remarks:		
Division	TDK Electronics AG, Ma	agnetics Business Group (MAG)	1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906) Traces are		
Address	Rosenheimer Strasse 1*	16b, 81669 Munich	product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated		
	Tel: +49 89 54020 3030	mailto: johann.reindl@tdk-electronics.tdk.com	 This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or 		
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The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS - Exemptions for the Product Class / Product according to Annex III: (🗹 valid 🗆 not valid)

 \boxdot no exemptions;

Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;

Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;

Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;

Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);

Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

Other Exemption than above